ASSP

# Dual Serial Input PLL FrequencySynthesizer

# **MB15F03L**

#### **■ DESCRIPITON**

The Fujitsu MB15F03L is a serial input Phase Locked Loop (PLL) frequency synthesizer with a 1800MHz and a 250MHz prescalers. A 64/65 or a 128/129 for the 1800MHz prescaler, and a 16/17 or a 32/33 for 250MHz prescaler can be selected that enables pulse swallow operation.

The latest BiCMOS process technology is used, resultantly a supply current is limited as low as 5.0mA typ. at a supply voltage of 3.0V.

Furthermore, a super charger circuit is included to provide a fast tuning as well as low noise performance. As a result of this, MB15F03L is ideally suitable for digital mobile communications, such as PHS(Personal Handy Phone System), PCN (Personal Communication Network) and PCS(Personal Communication Service).

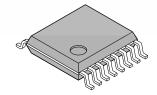
#### **■ FEATURES**

- High frequency operation RF synthesizer: 1800MHz max. / IF synthesizer: 250MHz max.
- Low power supply voltage: Vcc = 2.7 to 3.6V
- Very Low power supply current : Icc = 5.0 mA typ. (Vcc = 3V)
- Power saving function: Supply current at power saving mode Typ.0.1μA (Vcc=3V), Max.10μA (IPs1=IPs2)
- Dual modulus prescaler: 1800MHz prescaler(64/65,128/129), 250MHz prescaler(16/17,32/33)
- Serial input 14-bit programmable reference divider: R = 5 to 16,383
- Serial input 18-bit programmable divider consisting of:
  - Binary 7-bit swallow counter: 0 to 127
  - Binary 11-bit programmable counter: 5 to 2,047
- On-chip high performance charge pump circuit and phase comparator, achieving high-speed lock-up and low phase noise
- On-chip phase control for phase comparator
- Wide operating temperature: Ta = -40 to 85°C

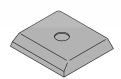
#### ■ PACKAGE



16-pin, Plastic SSOP

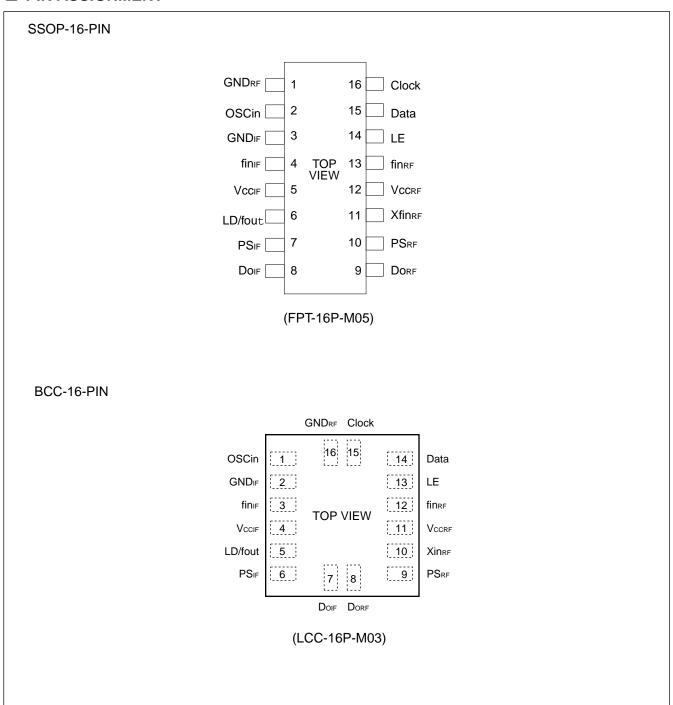


16-pin, Plastic BCC



D MOS) (LCC 16D N

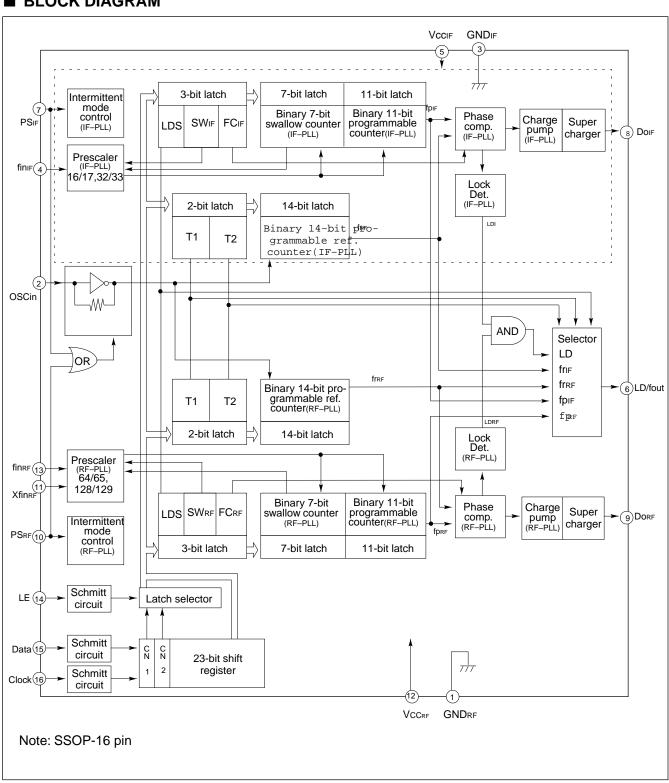
## **■ PIN ASSIGNMENT**



## **■ PIN DESCRIPTION**

Pin No.		Pin		Descriptions				
SSOP-16	BCC-16	name	I/O	Descriptions				
1	16	GNDrf	_	Ground for RF-PLL section.				
2	1	OSCin	I	The programmable reference divider input. TCXO should be connected with a AC coupling capacitor.				
3	2	GNDıF	_	Ground for the IF-PLL section.				
4	3	finıF	I	Prescaler input pin for the IF-PLL. The connection with VCO should be AC coupling.				
5	4	Vccif	_	Power supply voltage input pin for the IF-PLL section.				
6	5	LD/fout	0	Lock detect signal output (LD) / phase comparator monitoring output (fout) The output signal is selected by a LDS bit in a serial data. LDS bit = "H"; outputs fout signal LDS bit = "L"; outputs LD signal				
7	6	PSIF	I	Power saving mode control for the IF-PLL section. This pin must be set at "L" Power-ON. (Open is prohibited.) PSIF = "H"; Normal mode PSIF = "L"; Power saving mode				
8	7	Doif	0	Charge pump output for the IF-PLL section. Phase characteristics of the phase detector can be reversed by FC-bit.				
9	8	Dorf	0	Charge pump output for the RF-PLL section. Phase characteristics of the phase detector can be reversed by FC-bit.				
10	9	PSRF	I	Power saving mode control for the RF-PLL section. This pin must be set at "L" Power-ON. (Open is prohibited.)  PSRF = "H"; Normal mode  PSRF = "L"; Power saving mode				
11	10	Xfinrf	I	Prescaler complimentary input for the RF-PLL section. This pin should be grounded via a capacitor.				
12	11	Vccrf	_	Power supply voltage input pin for the RF-PLL section, the shift register and the oscillator input buffer. When power is OFF, latched data of RF-PLL is cancelled.				
13	12	finrf	I	Prescaler input pin for the RF-PLL. The connection with VCO should be AC coupling.				
14	13	LE	ı	Load enable signal input (with the schmitt trigger circuit.) When LE is "H", data in the shift register is transferred to the corresponding latch according to the control bit in a serial data.				
15	14	Data	I	Serial data input (with the schmitt trigger circuit.) A data is transferred to the corresponding latch (IF-ref counter, IF-prog. counter, RF-ref. counter, RF-prog. counter) according to the control bit in a serial data.				
16	15	Clock	I	Clock input for the 23-bit shift register (with the schmitt trigger circuit.) One bit data is shifted into the shift register on a rising edge of the clock.				

#### **■ BLOCK DIAGRAM**



#### ■ ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Rating	Unit	Remark
Power supply voltage	Vcc	-0.5 to +4.0	V	
Input voltage	Vı	-0.5 to Vcc +0.5	V	
Output voltage	Vo	-0.5 to Vcc +0.5	V	
Output ourrant	lo	-10 to +10	mA	Except Do
Output current	ldo	-25 to +25	mA	Do output
Storage temperature	Тѕтс	-55 to +125	°C	

WARNING: Semiconductor devices can be permanently damaged by application of stress (voltage, current, temperature, etc.) in excess of absolute maximum ratings. Do not exceed these ratings.

#### ■ RECOMMENDED OPERATING CONDITIONS

Parameter	Symbol		Value		Unit	Note	
Parameter	Symbol	Min	Тур	Max	Onit	Note	
Power supply voltage	Vcc	2.7	3.0	3.6	V	Vccif=Vccrf	
Input voltage	Vi	GND	_	Vcc	V		
Operating temperature	Та	-40	_	+85	°C		

WARNING: Recommended operating conditions are normal operating ranges for the semiconductor device. All the device's electrical characteristics are warranted when operated within these ranges.

Always yse semiconductor devices within the recommended operating conditions. Operation outside these ranges may adversely affect reliability and could result in device failure.

No warranty is made with repect to uses, operating conditions, or combinations not represented on the data sheet. Users considering application outside the listed conditions are advised to contact their FUJITSU representative beforehand.

#### **Handling Precautions**

- This device should be transported and stored in anti-static containers.
- This is a static-sensitive device; take proper anti-ESD precautions. Ensure that personnel and equipment are properly grounded. Cover workerbenches with grounded conductive mats.
- Always turn the power supply off before inserting or removing the device from its socket.
- Protect leads with a conductive sheet when handling or transporting PC boards with devices.

## **■ ELECTRICAL CHARACTERISTICS**

(Vcc=2.7V to 3.6V, Ta=-40°C to 85°C)

			2 1111	(-	Value	5.0 v, 1a=-40 v	
Paramete	er	Symbol	Condition	Min.	Тур.	Max.	Unit
Power supply curi	ront	Iccif*1	finif = 233.15MHz, fosc = 12MHz	_	1.5	_	mA.
Tower supply current		Iccrf*2	finrf = 1800MHz, fosc = 12MHz	_	3.5	_	IIIA
_		IpsıF	Vccif current at PSif ="L"	_	0.1*3	10	μΑ
Power saving curr	eni	Ipsrf	Vccrf current at PSif/Rf ="L"	_	0.1*3	10	
	fin <sub>IF</sub> *4	finır	IF-PLL	50	_	250	
Operating frequency	finre <sup>*4</sup>	finrf	RF-PLL	100	_	1800	MHz
	OSCin	fosc	_	3	_	40	
	finıF	Vfinif	IF–PLL, 50Ω termination	-10	_	+2	dBm
Input sensitivity	finre	Vfinrf	RF–PLL, 50Ω termination	-10	_	+2	dBm
	OSCin	Vosc	_	0.5	_	Vcc	Vp-p
	Data, VIH		Schmitt trigger input	Vccx0.7+ 0.4	_	_	V
Input voltage	LE	VIL	Schmitt trigger input	_	_	Vccx0.3 -0.4	V
	PSIF,	Vih	_	Vccx0.7	_	_	V
	PSRF	VIL	_	_	_	Vccx0.3	, v
	Data,	IIH*5	_	-1.0		+1.0	
Input current	Clock, LE, PS <sub>IF</sub> , PS <sub>RF</sub>	<b>l</b> ı∟* <sup>5</sup>	_	-1.0	_	+1.0	μΑ
	OCC:-	Іін	_	0	_	+100	
	OSCin	Iı∟*5	_	-100	_	0	μΑ
	LD/fout	Vон	Iон=-1.0mA	Vcc-0.4	_	_	V
Output voltage	LD/IOUL	Vol	IoL= 1.0mA	_	_	0.4	
Output voltage	Doif,	VDOH	IDOH =-1.0mA	Vcc-0.4		_	V
	Dorf	Vdol	Vcc=3.0V, IDOL=1.0mA	_		0.4	<b>'</b>
High impedance cutoff current	Doif, Dorf	loff	Vcc-3 0V			3.0	nA

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(Vcc=2.7V to 3.6V, Ta=-40°C to 85°C)

Doromot	Parameter		Symbol Condition		Value			
Paramet			Condition	Min.	Тур.	Max.	Unit	
	LD/fout		Vcc = 3.0V	-1.0	_	_	mA	
	LD/Iout	loL	Vcc = 3.0V	_	_	1.0	IIIA	
Output current	Doif,	IDOH*5	Vcc = 3.0V, VDOH = 2.0V , Ta=25°C	-11	_	-6	mA	
	Dorf	IDOL	Vcc = 3.0V, Vdol = 1.0V, Ta=25°C	8	_	15		

<sup>\*1:</sup> Conditions; Vccif = 3V, Ta = 25°C, in locking state.

<sup>\*2:</sup> Conditions; Vccrf = 3V, Ta = 25°C, in locking state.

<sup>\*3:</sup> fosc = 12.8 MHz , Vcc = 3.0V, Ta = 25 $^{\circ}C$ 

<sup>\*4:</sup> AC coupling with a 1000pF capacitor connected.

<sup>\*5:</sup> The symbol "-"(minus) means direction of current flow.

#### **■ FUNCTIONAL DESCRIPTIONS**

The divide ratio can be calculated using the following equation:

$$f_{VCO} = \{(P \times N) + A\} \times f_{OSC} \div R \quad (A < N)$$

fvco: Output frequency of external voltage controlled oscillator (VCO)

P: Preset divide ratio of dual modulus prescaler (16 or 32 for IF-PLL, 64 or 128 for RF-PLL)

N: Preset divide ratio of binary 11-bit programmable counter (5 to 2,047)

A: Preset divide ratio of binary 7-bit swallow counter ( $0 \le A \le 127$ )

fosc: Reference oscillation frequency

R: Preset divide ratio of binary 14-bit programmable reference counter (5 to 16,383)

#### **Serial Data Input**

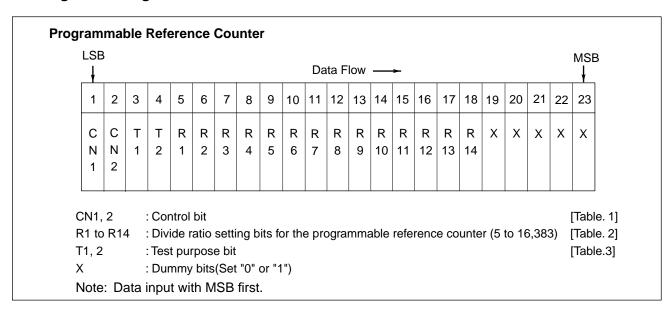
Serial data is entered using three pins, Data pin, Clock pin, and LE pin. Programmable dividers of IF/RF–PLL sections, programmable reference dividers of IF/RF PLL sections are controlled individually. Serial data of binary data is entered through Data pin.

On rising edge of clock, one bit of serial data is transferred into the shift register. When load enable signal is high, the data stored in the shift register is transferred to one of latch of them depending upon the control bit data setting.

Con	trol bit	Destination of earlied date			
CN1	CN2	Destination of serial data			
L	L	The programmable reference counter for the IF-PLL.			
Н	L	The programmable reference counter for the RF-PLL.			
L	Н	The programmable counter and the swallow counter for the IF-PLL			
Н	Н	The programmable counter and the swallow counter for the RF-PLL			

Table1. Control Bit

### **Shift Register Configuration**



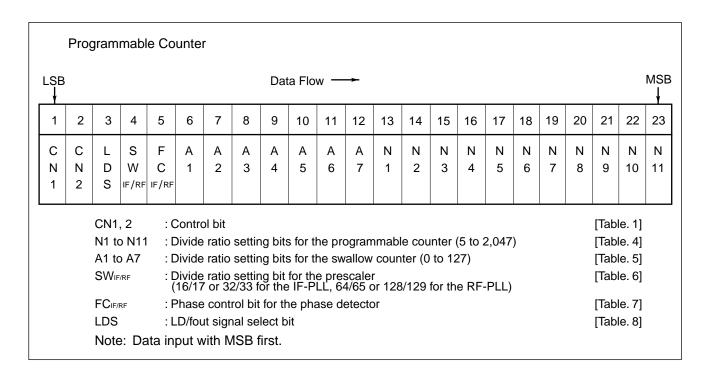


Table2. Binary 14-bit Programmable Reference Counter Data Setting

Divide ratio (R)	R 14	R 13	R 12	R 11	R 10	R 9	R 8	R 7	R 6	R 5	R 4	R 3	R 2	R 1
5	0	0	0	0	0	0	0	0	0	0	0	1	0	1
6	0	0	0	0	0	0	0	0	0	0	0	1	1	0
•	•	•	•	•	•	•	•	•	•	•	•	•	•	•
16383	1	1	1	1	1	1	1	1	1	1	1	1	1	1

Note: • Divide ratio less than 5 is prohibited.

**Table.3 Test Purpose Bit Setting** 

T 1	T 2	LD/fout pin state			
L	L	Outputs frif.			
Н	L	Outputs frrf.			
L	Н	Outputs fpif.			
Н	Н	Outputs fprf.			

**Table.4 Binary 11-bit Programmable Counter Data Setting** 

Divide ratio (N)	N 11	N 10	N 9	N 8	N 7	N 6	N 5	N 4	N 3	N 2	N 1
5	0	0	0	0	0	0	0	0	1	0	1
6	0	0	0	0	0	0	0	0	1	1	0
•	•	•	•	•	•	•	•	•	•	•	•
2047	1	1	1	1	1	1	1	1	1	1	1

Note: • Divide ratio less than 5 is prohibited.

**Table.5 Binary 7-bit Swallow Counter Data Setting** 

Divide ratio (A)	A 7	A 6	A 5	A 4	A 3	A 2	A 1
0	0	0	0	0	0	0	0
1	0	0	0	0	0	0	1
•	•	•	•	•	•	•	•
127	1	1	1	1	1	1	1

Note: • Divide ratio (A) range = 0 to 127

**Table. 6 Prescaler Data Setting** 

		SW = "H"	SW = "L"
Prescaler	IF-PLL	16/17	32/33
divide ratio	RF-PLL	64/65	128/129

**Table. 7 Phase Comparator Phase Switching Data Setting** 

	FCIF,RF = H	FCIF,RF = L
	Doif,Rf	Doif,RF
fr > fp	Н	L
fr = fp	Z	Z
fr < fp	L	Н
VCO polarity	(1)	(2)

Note: • Z = High-impedance

• Depending upon the VCO and LPF polarity, FC bit should be set.

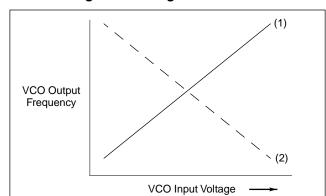
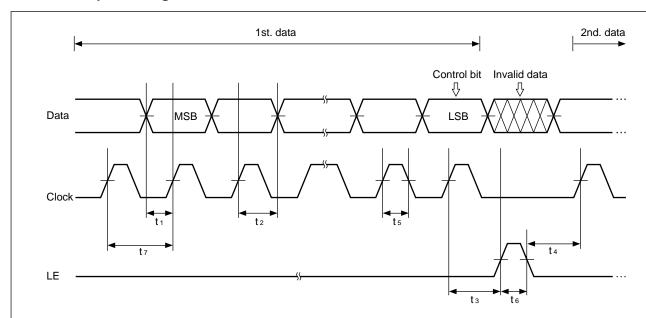


Table. 8 LD/fout Output Select Data Setting

LDS	LD/fout output signal	
Н	fout (frif/RF, fpif/RF) signals	
L	LD signal	

## **Serial Data Input Timing**

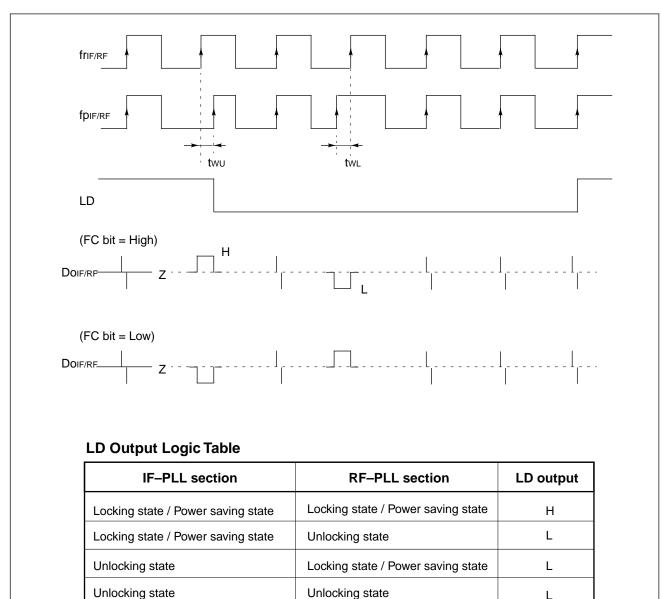


On rising edge of the clock, one bit of the data is transferred into the shift register.

Parameter	Min	Тур	Max	Unit
t1	20	_	_	ns
t2	20	_	-	ns
t3	30	_	_	ns
t4	20	_	-	ns

Parameter	Min	Тур	Max	Unit
t5	30	_	_	ns
t6	100	_	-	ns
t7	100	_	_	ns

### **■ PHASE DETECTOR OUTPUT WAVEFORM**



Note: •Phase error detection range =  $-2\pi$  to  $+2\pi$ 

- Pulses on DoiF/RF signals are output to prevent dead zone.
- •LD output becomes low when phase error is two or more.
- •LD output becomes high when phase error is twL or less and continues to be so for three cycles or more.
- •twu and twL depend on OSCin input frequency as follows.

 $twu \ge 4/fosc$ : i.e.  $twu \ge 312.5$ ns when foscin = 12.8 MHz twL < 8/fosc: i.e. twL < 625.0ns when foscin = 12.8 MHz

## **■ POWER SAVING MODE (INTERMITTENT MODE CONTROL CIRCUIT)**

Setting a  $PS_{IF(RF)}$  pin to Low, IF-PLL (RF-PLL) enters into power saving mode resultant current consumption can be limited to  $10\mu A$  (typ.). Setting PS pin to High, power saving mode is released so that the device works normally.

In addition, the intermittent operation control circuit is included which helps smooth start up from stand by mode. In general, the power consumption can be saved by the intermittent operation that powering down or waking up the synthesizer. Such case, if the PLL is powered up uncontrolled, the resulting phase comparator output signal is unpredictable due to an undefined phase relation between reference frequency (fr) and comparison frequency (fp) and may in the worst case take longer time for lock up of the loop.

To prevent this, the intermittent operation control circuit enforces a limited error signal output of the phase detector during power up. Thus keeping the loop locked.

PS pin must be set "L" at Power-ON.

Allow 1  $\mu s$  after frequency stabilization on power-up for exiting the power saving mode (PS: L to H)

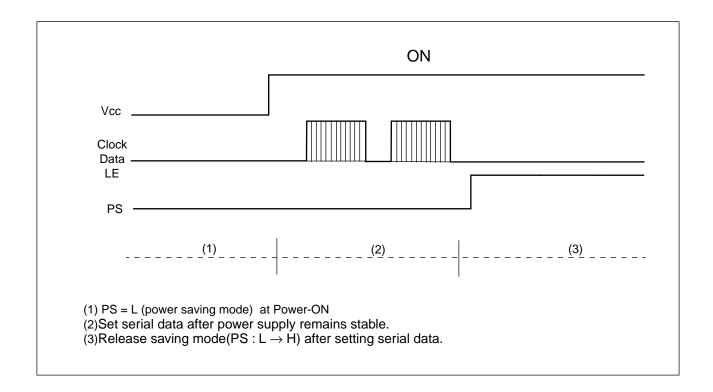
Serial data can be entered during the power saving mode.

During the power saving mode, the corresponding section except for indispensable circuit for the power saving function stops working, then current consumption is reduced to  $10\mu$ A per one PLL section.

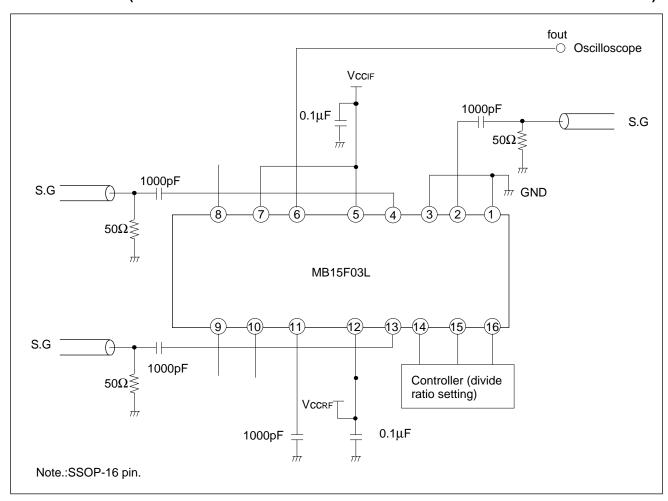
At that time, the Do and LD become the same state as when a loop is locking. That is, the Do becomes high impedance.

A VCO control voltage is naturally kept at the locking voltage which defined by a LPF's time constant. As a result of this, VCO's frequency is kept at the locking frequency.

PSIF	<b>PS</b> RF	IF-PLL counters	RF-PLL counters	OSC input buffer
L	L	OFF	OFF	OFF
Н	L	ON	OFF	ON
L	Н	OFF	ON	ON
Н	Н	ON	ON	ON

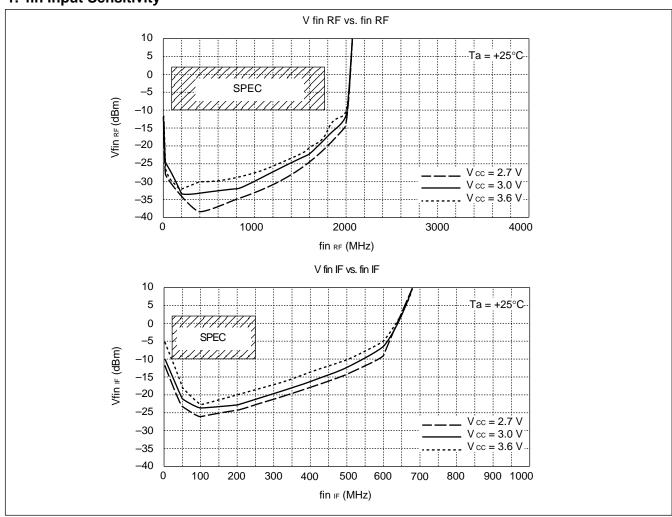


## ■ TEST CIRCUIT (PRESCALER INPUT/PROGRAMMABLE REFERENCE DIVIDER INPUT SENSITIVITYTEST)

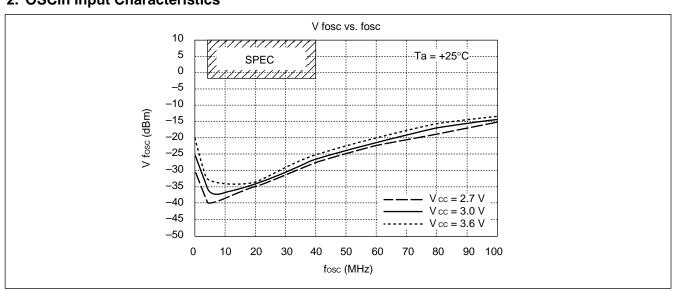


## **■ TYPICAL CHARACTERISITICS**

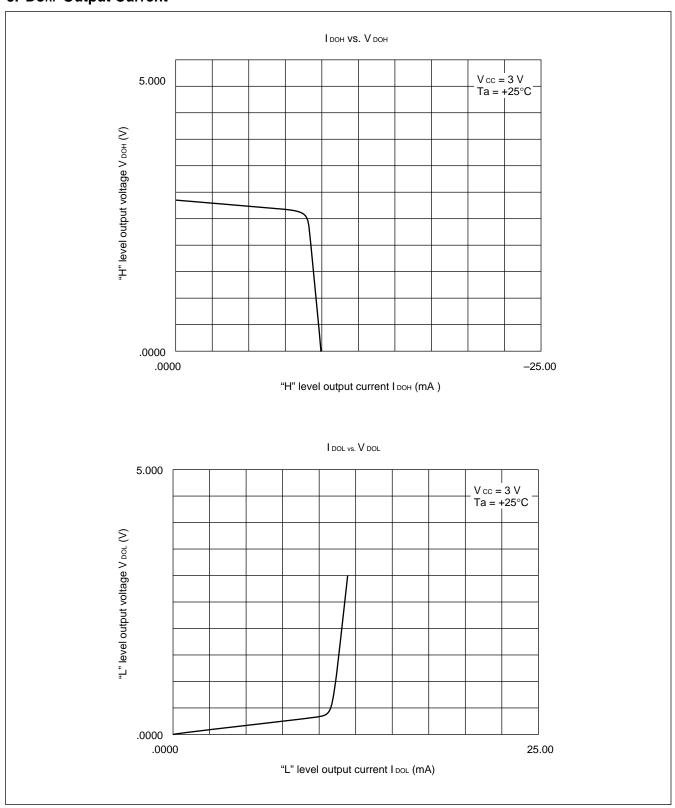
## 1. fin Input Sensitivity



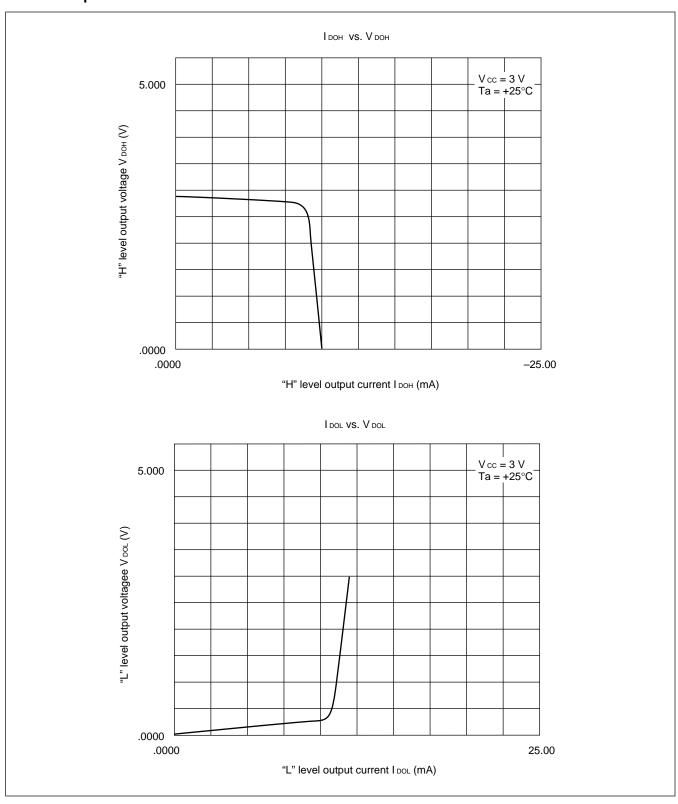
## 2. OSCin Input Characteristics



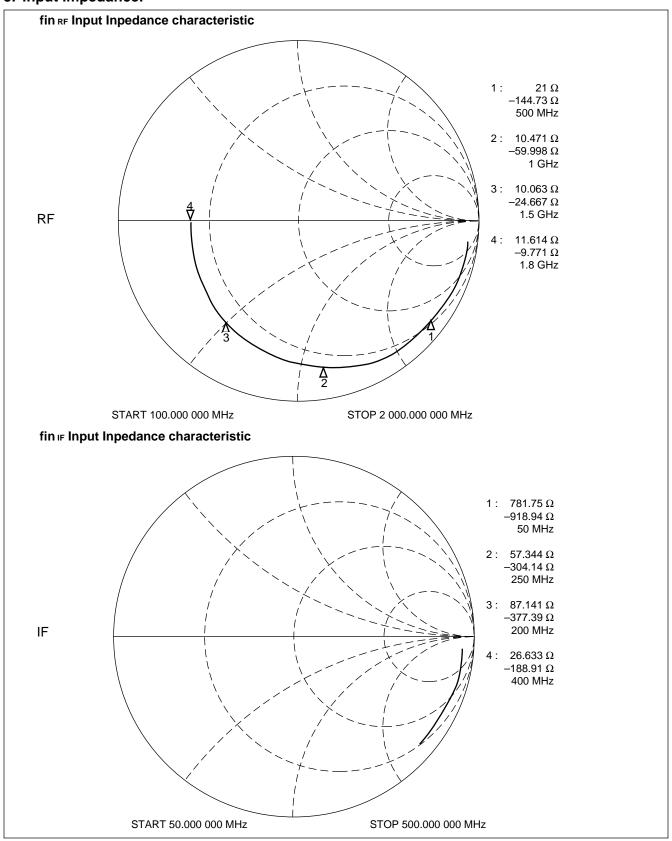
## 3. Dorf Output Current



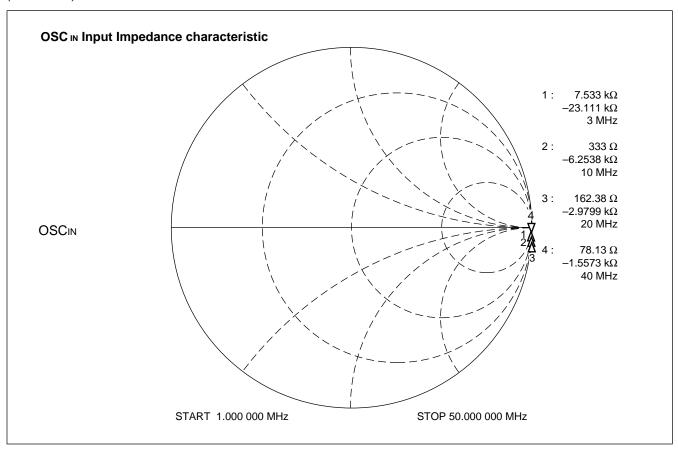
## 4. Doir Output Current



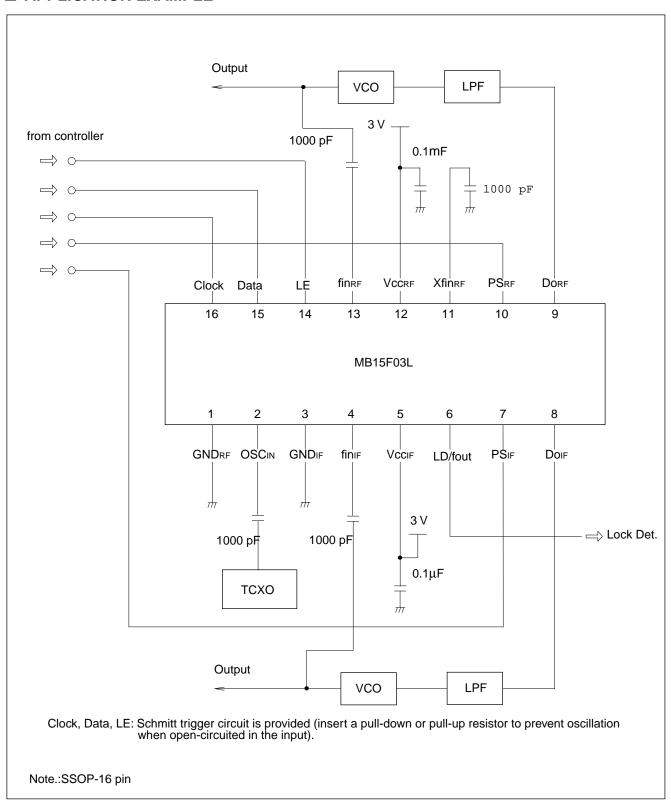
## 5. Input Impedance.



## (Continued)



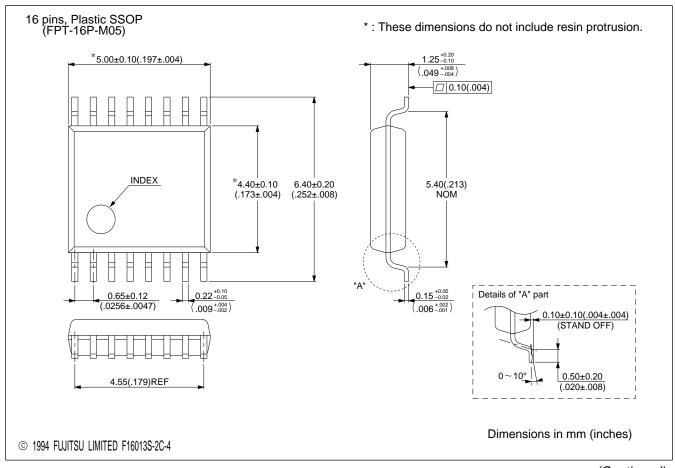
## **■ APPLICATION EXAMPLE**



## **■** ORDERING INFORMATION

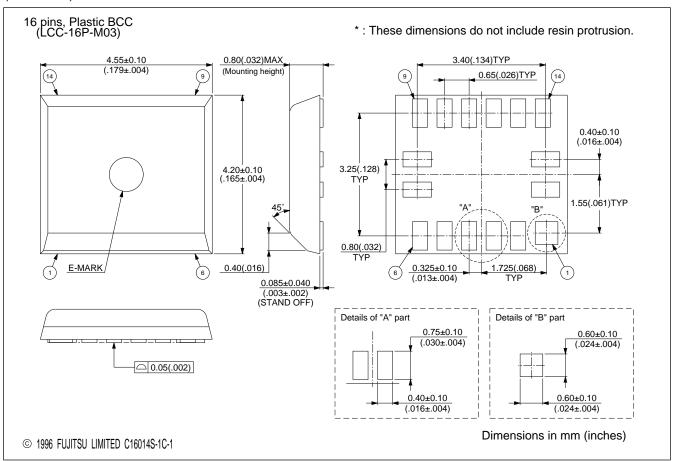
Part number	Package	Remarks
MB15F03L PFV	16pin, Plastic SSOP (FPT-16P-M05)	
MB15F03L PV	16pin, Plastic BCC (LCC-16P-M03)	

## **■ PACKAGE DIMENSION**



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